PRESS RELEASE



VPEC expands capacities with AIXTRON technology

Taiwanese epi foundry chooses AIXTRON MOCVD systems to meet growing demand for lasers and other devices

Herzogenrath/Germany, May 02, 2018 – AIXTRON SE (FSE: AIXA), a worldwide leading provider of deposition equipment to the semiconductor industry, will deliver high-end MOCVD technology to long-standing customer Visual Photonics Epitaxy Co. Ltd. (VPEC). The Taiwanese semiconductor foundry, mainly specialized in solutions for wireless and optical device epi wafers, plans to ramp-up its epitaxy production with multiple AIX 2800G4 MOCVD cluster systems to meet the globally growing demand for various photonic and electronic applications.

AIXTRON will deliver all AIX 2800G4 reactors with an 8x6-inch wafer configuration that enables maximum yield at the highest quality level available in the market. Being the tool of reference within the semiconductor industry for the manufacturing of diode lasers, such as VCSELs (vertical cavity edge emitting lasers) and EEL (edge emitting lasers), the AIX 2800G4 has built itself a strong reputation due to the unique product performance and the high volume manufacturing capabilities of the automated AIXTRON Planetary batch reactor concept.

Neil Chen, Senior Vice President of VPEC, comments: "AIXTRON is the leading provider of high-volume manufacturing equipment for arsenide phosphide (AsP) based materials. As a proven tool for high-volume production in the area of photonic applications, the AIX 2800G4 system delivers exactly the outstanding uniformity and reproducibility, but also flexibility and versatility that we require as an epi foundry to serve the needs of our demanding customers."

"Driven by the growing number of applications and the continuing penetration of high-end communication technology, the demand for arsenide phosphide based optoelectronic devices such as VCSELs or datacom lasers is expected to increase further. Based on a longstanding and trustful relationship with VPEC, we are looking forward to support the growth of one of the leading epi foundries in Asia", says Dr. Bernd Schulte, President of AIXTRON SE.

PRESS RELEASE



About AIXTRON

AIXTRON SE is a leading provider of deposition equipment to the semiconductor industry. The Company was founded in 1983 and is headquartered in Herzogenrath (near Aachen), Germany, with subsidiaries and sales offices in Asia, United States and in Europe. AIXTRON's technology solutions are used by a diverse range of customers worldwide to build advanced components for electronic and opto-electronic applications based on compound, or organic semiconductor materials. Such components are used in a broad range of innovative applications, technologies and industries. These include LED applications, display technologies, data storage, data transmission, energy management and conversion, communication, signaling and lighting as well as a range of other leading-edge technologies.

Our registered trademarks: AIXACT®, AIXTRON®, APEVA®, Atomic Level SolutionS®, Close Coupled Showerhead®, CRIUS®, EXP®, EPISON®, Gas Foil Rotation®, Optacap™, OVPD®, Planetary Reactor®, PVPD®, STExS®, TriJet®

For further information on AIXTRON (FSE: AIXA, ISIN DE000A0WMPJ6) please visit our website at: www.aixtron.com.

About VPEC

Visual Photonics Epitaxy Co. Ltd., a semiconductor epitaxial wafer pure play foundry, was founded in 1996 and is based in Ping-Jen City, Taiwan. The company provides solutions for wireless communications, optical fiber communications, and solar cell applications.

For further information, please visit: http://www.vpec.com.tw/vpec/homeweb/homeweb e/index.php

Forward-Looking Statements

This document may contain forward-looking statements regarding the business, results of operations, financial condition and earnings outlook of AIXTRON. These statements may be identified by words such as "may", "will", "expect", "anticipate", "contemplate", "intend", "plan", "believe", "continue" and "estimate" and variations of such words or similar expressions. These forward-looking statements are based on our current assessments, expectations and assumptions, of which many are beyond control of AIXTRON, and are subject to risks and uncertainties. You should not place undue reliance on these forward-looking statements. Should these risks or uncertainties materialize, or should underlying expectations not occur or assumptions prove incorrect, actual results, performance or achievements of AIXTRON may materially vary from those described explicitly or implicitly in the relevant forward-looking statement. This could result from a variety of factors, such as actual customer orders received by AIXTRON, the level of demand for deposition technology in the market, the timing of final acceptance of products by customers, the condition of financial markets and access to financing for AIXTRON, general conditions in the market for deposition plants and macroeconomic conditions, cancellations, rescheduling or delays in product shipments, production capacity constraints, extended sales and qualification cycles, difficulties in the production process, the general development in the semi-conductor industry, increased competition, fluctuations in exchange rates, availability of public funding, fluctuations and/or changes in interest rates, delays in developing and marketing new products, a deterioration of the general economic situation and any other factors discussed in any reports or other announcements, in particular in the chapter Risks in the Annual Report, filed by AIXTRON. Any forward-looking statements contained in this document are based on current expectations and projections of the executive board based on information available the date hereof. AIXTRON undertakes no obligation to revise or update any forward-looking statements as a result of new information, future events or otherwise, unless expressly required to do so by law.

This document is an English language translation of a document in German language. In case of discrepancies, the German language document shall prevail and shall be the valid version.